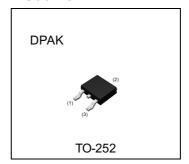
Parameter	Value
V <sub>CEO</sub>	80V
IC	2A

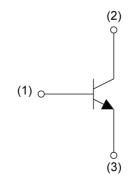
#### Outline



### Features

- 1) Suitable for Power Driver.
- 2) Complementary PNP Types: 2SAR574D3.
- 3) Low  $V_{CE(sat)}$   $V_{CE(sat)}$ =300mV(Max.). ( $I_C/I_B$ =1A/50mA)

### ●Inner circuit



- (1) Base
- (2) Collector
- (3) Emitter

### Application

LOW FREQUENCY AMPLIFIER

### Packaging specifications

Part No.	Package	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SCR574D3	TO-252	TL	330	16	2500	2SCR574D3
25CR374D3		TL1				

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	$V_{CBO}$	80	V
Collector-emitter voltage		80	V
Emitter-base voltage	V <sub>EBO</sub>	6	V
Calla star a como et	I <sub>C</sub>	2	Α
Collector current	I <sub>CP</sub> *1	4	Α
Power dissipation	P <sub>D</sub> *2	10	W
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic	
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = 100μA	80	-	-	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	80	-	1	V	
Emitter-base breakdown voltage	$BV_{EBO}$	I <sub>E</sub> = 100μA	6	-	-	V	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 80V	-	-	1	μA	
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 4V	-	-	1	μA	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 1A, I <sub>B</sub> = 50mA	-	100	300	mV	
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = 3V, I <sub>C</sub> = 100mA	120	-	390	-	
Transition frequency	f <sub>T</sub> *3	V <sub>CE</sub> = 10V, I <sub>E</sub> = -500mA, f = 100MHz	-	280	-	MHz	
Output capacitance	itance $C_{ob}$ $V_{CB} = 10V, I_E = 0A,$ $f = 1MHz$		-	20	1	pF	
Turn-On time	t <sub>on</sub>	I <sub>C</sub> = 1A, I <sub>B1</sub> = 100mA,	ı	90	ı	ns	
Storage time	$t_{stg}$	$I_{B2} = -100 \text{mA},$ $V_{CC} \approx 10 \text{V},$	ı	600	1	ns	
Fall time	t <sub>f</sub>	$R_L = 10\Omega$ See test circuit	-	150	-	ns	

<sup>\*1</sup> Pw=10ms Single Pulse

<sup>\*2</sup> T<sub>c</sub>=25℃

<sup>\*3</sup> Pulsed

### ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.1 Grounded Emitter Propagation Characteristics

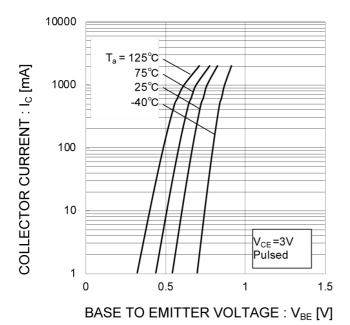
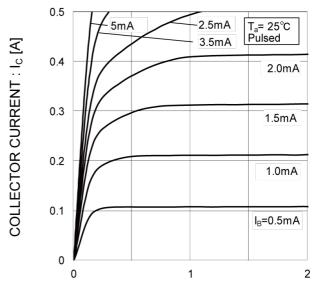


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC Current Gain vs. Collector Current(I)

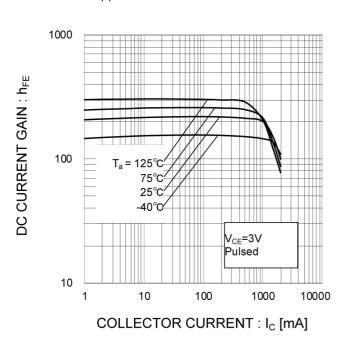
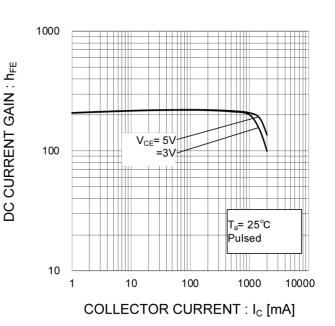


Fig.4 DC Current Gain vs. Collector Current(II)



### ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current(I)

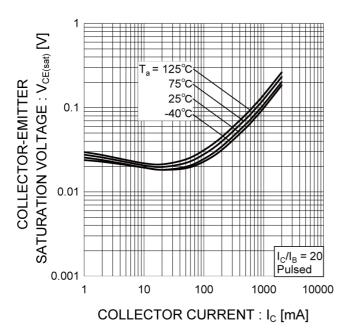


Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)

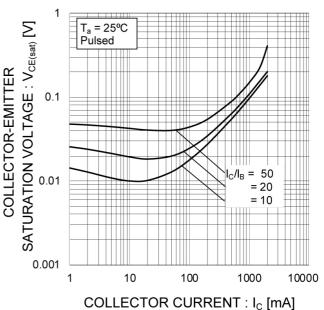


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

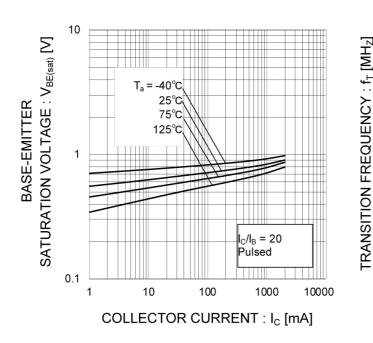
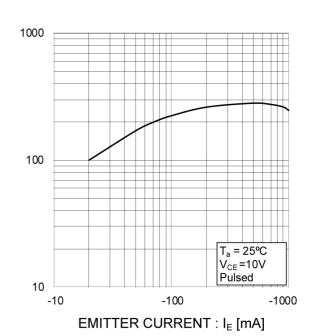


Fig.8 Gain Bandwidth Product vs. Emitter Current



### ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.9 Emitter input capacitance vs. Emitter-Base Voltage

Collector output capacitance vs.

Collector-Base Voltage

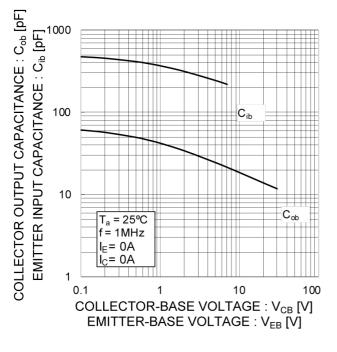
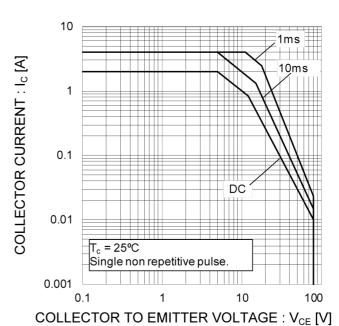
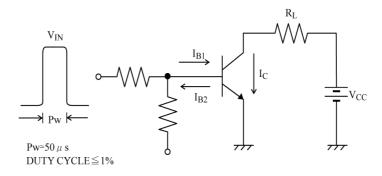
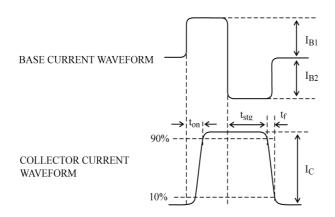


Fig.10 Safe Operating Area

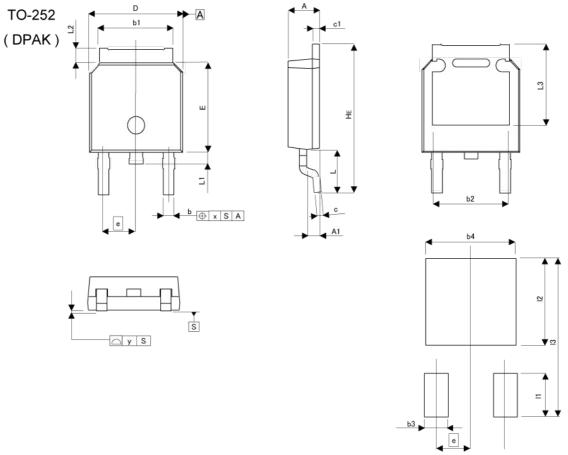


#### SWITCHING TIME TEST CIRCUIT





### ullet Dimensions (TL)



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

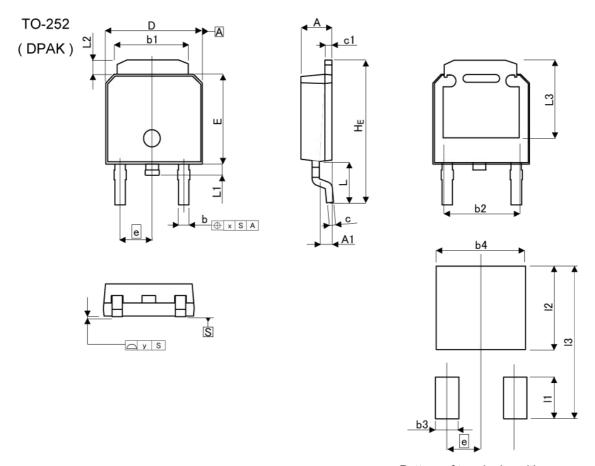
DIM	MILIME	TERS	INCI	HES
DIM	MIN	MAX	MIN	MAX
Α	2.10	2.30	0.083	0.091
A1	0.70	1.10	0.028	0.043
b	0.65	0.85	0.026	0.033
b1	5.10	5.40	0.201	0.213
b2	5.	10	0.2	.01
С	0.40	0.60	0.016	0.024
c1	0.40	0.60	0.016	0.024
D	6.40	6.80	0.252	0.268
е	2.	30	0.091	
E	6.00	6.40	0.236	0.252
HE	9.50	10.50	0.374	0.413
L	2.	90	0.1	14
L1	0.70	0.90	0.028	0.035
L2	0.70	1.30	0.028	0.051
L3	5.	30	0.2	:09
Х	-	0.10	y-	0.004
у	-	0.10	-	0.004

	DIM	MILIMETERS		INCHES		
		MIN	MAX	MIN	MAX	
	b3	-	1.10	020	0.043	
	b4	-	5.40	2. <b>-</b> 3	0.213	
	I1	2 ,	2.90	-	0.114	
	12	-	5.50	11-11	0.217	
	13	2	10.50	72	0.413	

Dimension in mm/inches



### ● Dimensions (TL1)



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIME	TERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	2.20	2.40	0.087	0.094
A1	0.70	1.10	0.028	0.043
b	0.60	0.90	0.024	0.035
b1	5.20	5.50	0.205	0.217
b2	5.	35	0.2	211
С	0.40	0.60	0.016	0.024
c1	0.40	0.60	0.016	0.024
D	6.40	6.80	0.252	0.268
е	2.	30	0.091	
E	6.00	6.40	0.236	0.252
HE	9.40	10.40	0.370	0.409
L	2.	70	0.10	
L1	0.60	1.00	0.024	0.039
L2	0.70	1.30	0.028	0.051
L3	5.	30	0.2	209
x	3	0.25	-	0.010
у	-	0.10	-	0.004

DIM	MILIMETERS		INCHES		
DIIVI	MIN	MAX	MIN	MAX	
b3	-	1.15	2	0.045	
b4	-	5.55	-	0.219	
11	-	2.77	2	0.109	
12	1-0	5.50	-	0.217	
13		10.40		0.409	

Dimension in mm/inches



# **Notice**

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(Note1) Medical Equipment Classification of the Specific Applications

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JAPAN	USA	EU	CHINA
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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
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  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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